

Temperature Rise Data

Product High Power Chip Resist	ors <wid< th=""><th>e Terminal</th><th>type><anti-surge></anti-surge></th><th>Series</th><th>LTR series</th><th>Туре</th><th>LTR100 JZP</th><th>Rated Power</th><th>2.0W</th></wid<>	e Terminal	type> <anti-surge></anti-surge>	Series	LTR series	Туре	LTR100 JZP	Rated Power	2.0W
Test conditions Ambient temperature: Board specifications Cu foil thickness Number of layers of Cu foil Sample size Direct current application	: 25°C	C 4 t = 1.6 m m	Test conditions Ambient tel Board spec Cu foil thick Number of Sample siz	mperature: cifications kness layers of Cu foil e ent application Thot spot Terminal 2Hot spot	: 25°C : FR-4 t = 1 : 70μm	1.6 mm	100	Hot spot Term	
				定格電力比(% Power rating	•		(2.0W)		

[Caution]

This data is the value of specific lot and specific resistance value only. It does not guarantee the variations due to different lot and product.

This data is not guaranteed. This data shall be utilized as reference data of the actual product characteristic.

When deciding the usage of the product, we cordially ask you not to only rely on this data but to have own evaluation and verification.

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